

High speed DuoPack: IGBT in Trench and Fieldstop technology with soft, fast recovery anti-parallel diode

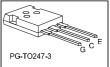
Features:

- TRENCHSTOP[™] technology offering
- very low V_{CEsat}
- low EMI
- Very soft, fast recovery anti-parallel diode
- maximum junction temperature 175°C
- qualified according to JEDEC for target applications
- Pb-free lead plating; RoHS compliant
- complete product spectrum and PSpice Models: http://www.infineon.com/igbt/

Applications:

- uninterruptible power supplies
- welding converters
- · converters with high switching frequency





Туре	VCE	<i>l</i> c	V _{CEsat} , T _{vj} =25°C	\mathcal{T}_{vjmax}	Marking	Package
IKW30N60H3	600V	30A	1.95V	175°C	K30H603	PG-TO247-3

Maximum ratings

Parameter	Symbol	Value	Unit
Collector-emitter voltage	VCE	600	V
DC collector current, limited by T_{vjmax} $T_{C} = 25^{\circ}C$ $T_{C} = 100^{\circ}C$	k	60.0 30.0	A
Pulsed collector current, t limited by T _{vjmax}	Cpuls	120.0	A
Turn off safe operating area $V_{CE} \le 600V$, $T_{vj} \le 175^{\circ}C$	-	120.0	A
Diode forward current, limited by T_{vjmax} $T_{C} = 25^{\circ}C$ $T_{C} = 100^{\circ}C$	Æ	30.0 15.0	A
Diode pulsed current, \not{a} limited by T_{vjmax}	Fpuls	120.0	Α
Gate-emitter voltage	V _{GE}	±20	V
Short circuit withstand time $V_{GE} = 15.0V$, $V_{CC} \le 400V$, $T_{vj} \le 150^{\circ}C$ Allowed number of short circuits < 1000 Time between short circuits: $\ge 1.0s$	<i>t</i> sc	5	μs
Power dissipation $T_{\rm C}$ = 25°C Power dissipation $T_{\rm C}$ = 100°C	Ptot	187.0 94.0	W
Operating junction temperature	T _{vj}	-40+175	°C
Storage temperature	T _{stg}	-55+150	°C
Soldering temperature, wavesoldering 1.6 mm (0.063 in.) from case for 10s		260	°C
Mounting torque, M3 screw Maximum of mounting processes: 3	M	0.6	Nm



Thermal Resistance

Parameter	Symbol	Conditions	Max. Value	Unit
Characteristic	I		1	- I
IGBT thermal resistance, junction - case	Rth(j-c)		0.80	K/W
Diode thermal resistance, junction - case	Rth(j-c)		1.90	K/W
Thermal resistance junction - ambient	R th(j⁻a)		40	K/W

Electrical Characteristic, at T_{vj} = 25°C, unless otherwise specified

Deremeter	Symbol		Value			11
Parameter	Symbol	Conditions	min.	typ.	max.	Unit
Static Characteristic					1	
Collector-emitter breakdown voltage	V(BR)CES	<i>V</i> _{GE} = 0V, <i>I</i> _C = 2.00mA	600	-	-	V
Collector-emitter saturation voltage	V∕CEsat	$V_{GE} = 15.0V, k = 30.0A$ $T_{vj} = 25^{\circ}C$ $T_{vj} = 125^{\circ}C$ $T_{vj} = 175^{\circ}C$	- - -	1.95 2.30 2.50	2.40 - -	v
Diode forward voltage	ŀ⊧	$V_{GE} = 0V, \not = 15.0A$ $T_{vj} = 25^{\circ}C$ $T_{vj} = 125^{\circ}C$ $T_{vj} = 175^{\circ}C$	- - -	1.65 1.67 1.65	2.05	v
Gate-emitter threshold voltage	V _{GE(th)}	$I_{\rm C} = 0.43 {\rm mA}, \ V_{\rm CE} = V_{\rm GE}$	4.1	5.1	5.7	V
Zero gate voltage collector current	<i>I</i> ces	$V_{CE} = 600V, V_{GE} = 0V$ $T_{vj} = 25^{\circ}C$ $T_{vj} = 175^{\circ}C$			40.0 1000.0	μA
Gate-emitter leakage current	<i>I</i> GES	<i>V</i> _{CE} = 0V, <i>V</i> _{GE} = 20V	-	-	100	nA
Transconductance	$g_{\sf fs}$	<i>V</i> _{CE} = 20V, <i>I</i> _C = 30.0A	-	16.0	-	S

Electrical Characteristic, at T_{vj} = 25°C, unless otherwise specified

Devenueter	Cumb al	Canditiana	Value			11
Parameter	Symbol	Conditions	min.	typ.	max.	Unit
Dynamic Characteristic						
Input capacitance	Cies	V _{CE} = 25V, V _{GE} = 0V, f = 1MHz	-	1630	-	
Output capacitance	Coes		-	107	-	pF
Reverse transfer capacitance	Cres		-	50	-	1
Gate charge	<i>Q</i> G	V _{CC} = 480V, <i>I</i> _C = 30.0A, V _{GE} = 15V	-	165.0	-	nC
Internal emitter inductance measured 5mm (0.197 in.) from case	LE		-	13.0	-	nH
Short circuit collector current Max. 1000 short circuits Time between short circuits: ≥ 1.0s	Ic(sc)	V _{GE} = 15.0V, V _{CC} ≤ 400V, 7 _{vj} ≤ 150°C, <i>t</i> _{SC} ≤ 5µs	-	160	-	A



Switching Characteristic, Inductive Load, at $T_{vj} = 25^{\circ}C$

Parameter	0 miles		Value			11
	Symbol	Conditions	min.	typ.	max.	Unit
IGBT Characteristic						
Turn-on delay time	İ d(on)	$T_{\rm vj} = 25^{\circ}{\rm C},$	-	21	-	ns
Rise time	<i>t</i> r	$V_{CC} = 400V, I_C = 30.0A,$ $V_{GE} = 0.0/15.0V,$ $I_G = 10.5\Omega, L_{\sigma} = 95nH,$ $C_{\sigma} = 67pF$ L_{σ}, C_{σ} from Fig. E Energy losses include "tail" and diode reverse recovery.	-	33	-	ns
Turn-off delay time	<i>t</i> d(off)		-	207	-	ns
Fall time	<i>t</i> f		-	22	-	ns
Turn-on energy	Eon		-	0.94	-	mJ
Turn-off energy	E _{off}		-	0.44	-	mJ
Total switching energy	Ets		-	1.38	-	mJ

Anti-Parallel Diode Characteristic, at $T_{vj} = 25^{\circ}C$

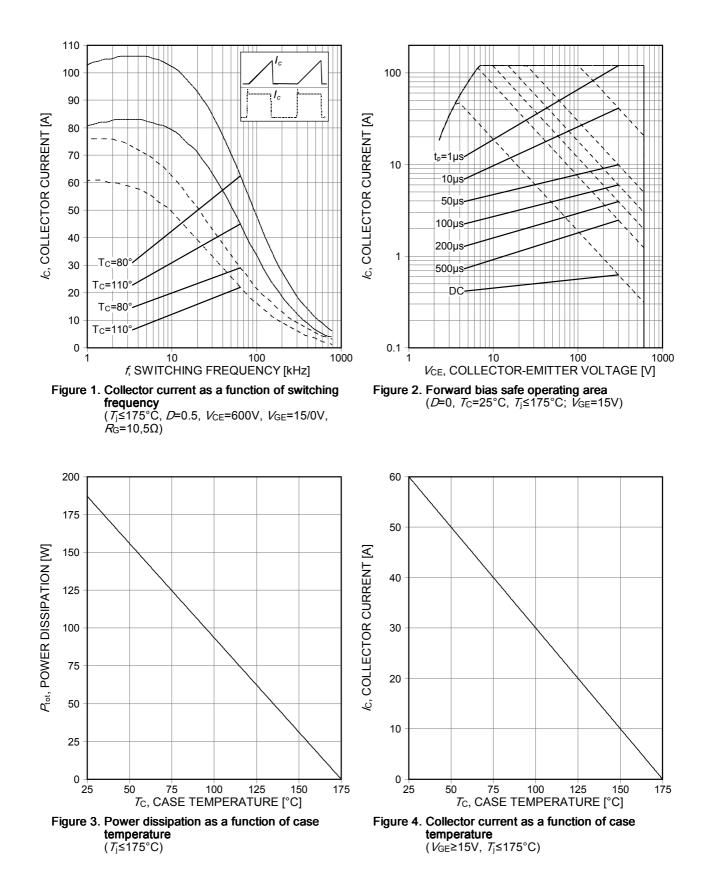
Diode reverse recovery time	<i>t</i> rr	$T_{\rm vj} = 25^{\circ} \rm C,$	-	38	-	ns
Diode reverse recovery charge	Qrr	I∕R = 400V, I∉ = 30.0A,	-	0.32	-	μC
Diode peak reverse recovery current	<i>I</i> rrm	<i>di</i> ⊧ <i>/dt</i> = 1000A/µs	-	12.0	-	Α
Diode peak rate of fall of reverse recovery current during $t_{\rm b}$	di _{rr} /dt		-	-765	-	A/µs

Switching Characteristic, Inductive Load, at T_{vj} = 175°C

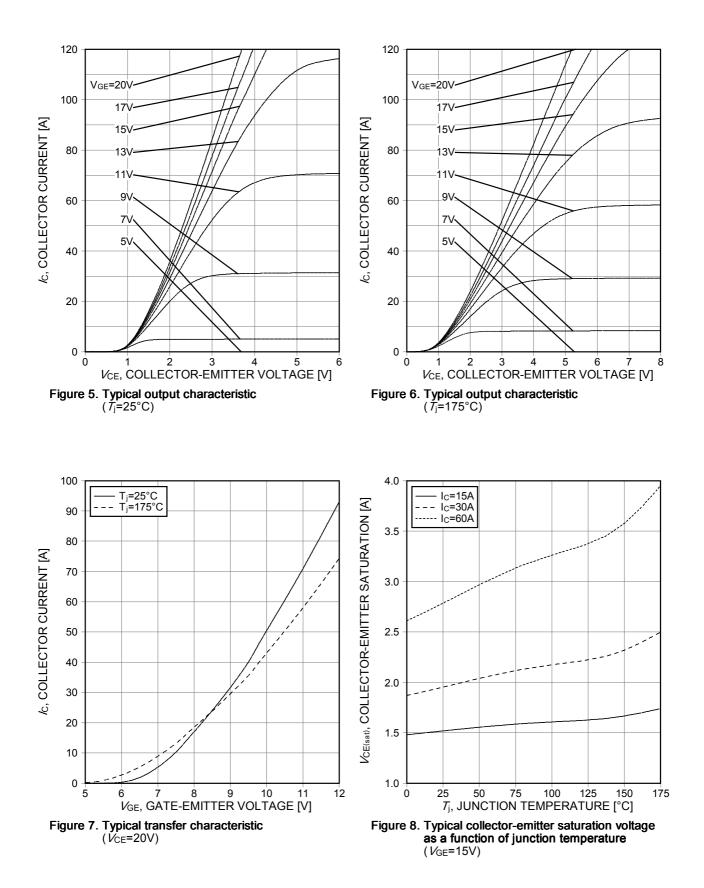
Parameter	Symbol Conditions		Value			11
		min.	typ.	max.	Unit	
IGBT Characteristic	·					
Turn-on delay time	<i>t</i> d(on)	<i>T</i> _{vj} = 175°C,	-	20	-	ns
Rise time	<i>t</i> r	$V_{CC} = 400V, I_C = 30.0A,$ $V_{GE} = 0.0/15.0V,$ $I_G = 10.5\Omega, L_{\sigma} = 95nH,$ $C_{\sigma} = 67pF$ L_{σ}, C_{σ} from Fig. E Energy losses include "tail" and diode reverse recovery.	-	30	-	ns
Turn-off delay time	<i>t</i> d(off)		-	239	-	ns
Fall time	<i>t</i> f		-	23	-	ns
Turn-on energy	Eon		-	1.12	-	mJ
Turn-off energy	$E_{\rm off}$		-	0.60	-	mJ
Total switching energy	Ets		-	1.72	-	mJ

Anti-Parallel Diode Characteristic, at T_{vj} = 175°C

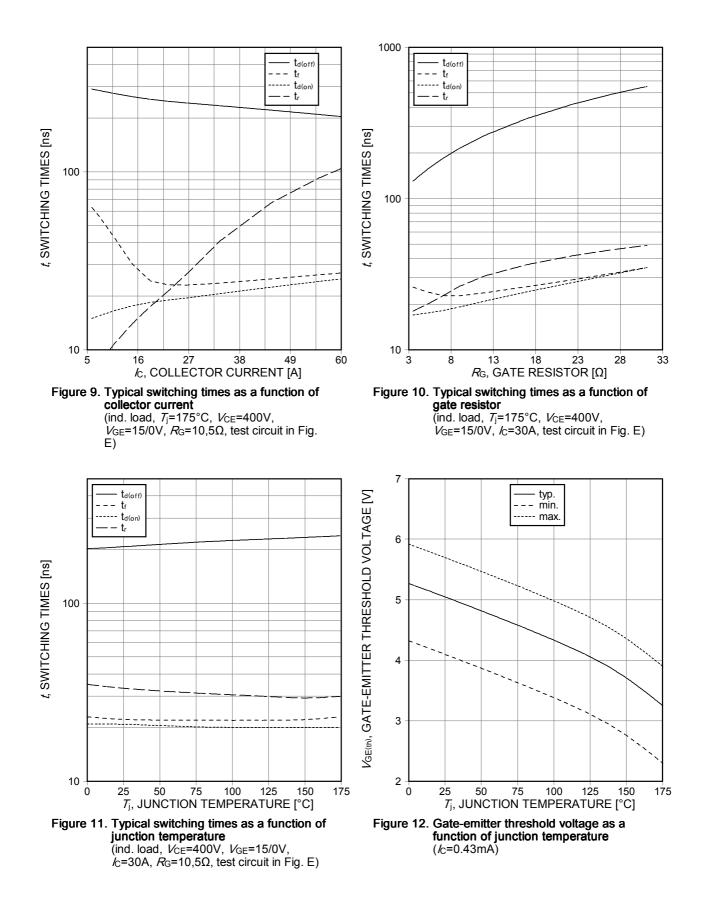
Diode reverse recovery time	<i>t</i> rr	$T_{\rm vj} = 175^{\circ}{\rm C},$	-	117	-	ns
Diode reverse recovery charge	Qrr	V _R = 400V, /= = 30.0A.	-	1.08	-	μC
Diode peak reverse recovery current	<i>I</i> rrm	<i>di</i> ⊧ <i>/dt</i> = 1000A/µs	-	16.6	-	Α
Diode peak rate of fall of reverse recovery current during to	di _{rr} /dt		-	-530	-	A/µs



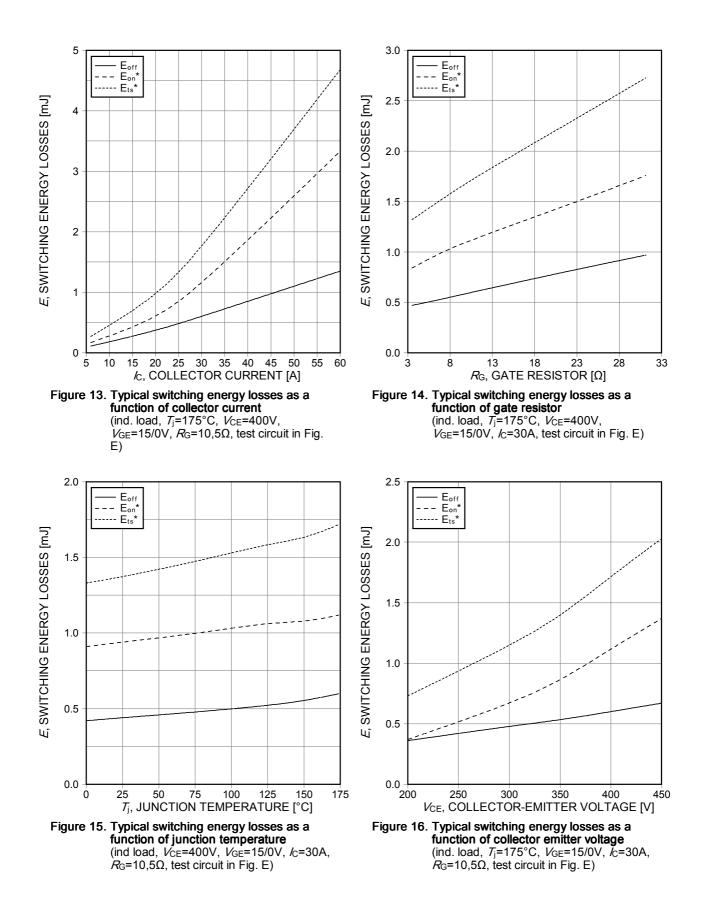




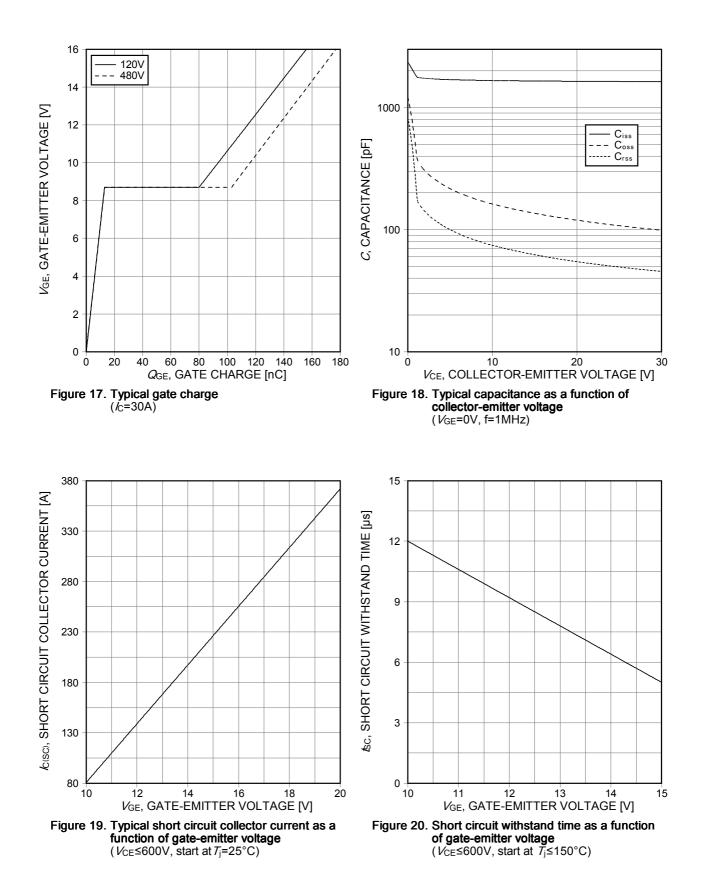




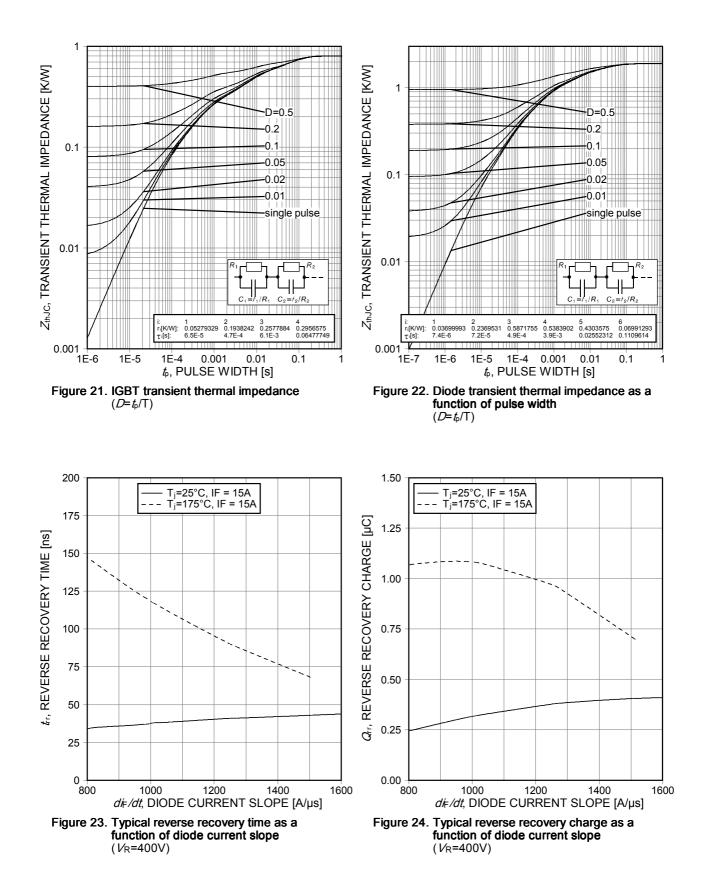




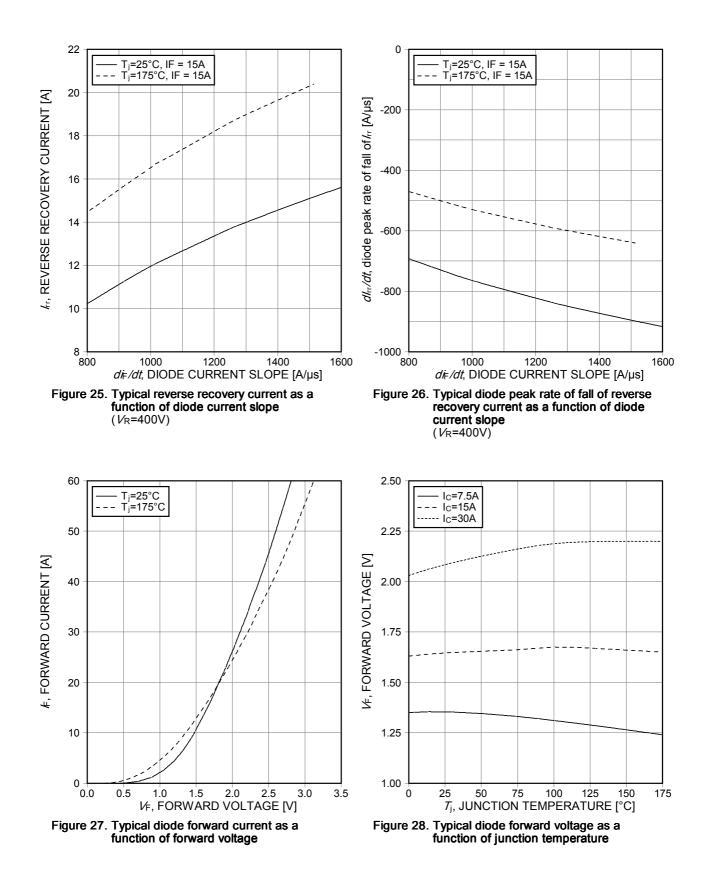






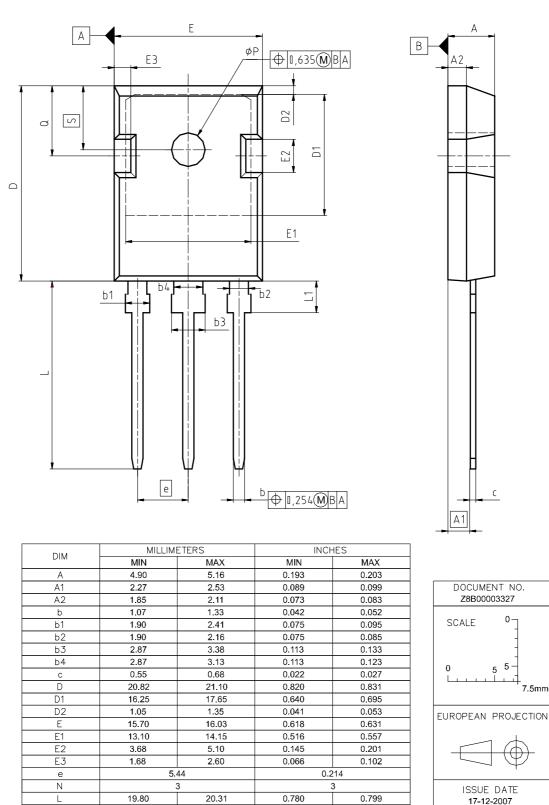








PG-TO247-3



REVISION

03

7.5mm

0.164

0.138

0.216

0.238

0.176

0.146

0.236

0.248

4.17

3.50

5.49

6.04

L1

øP

Q S

4.47

3.70

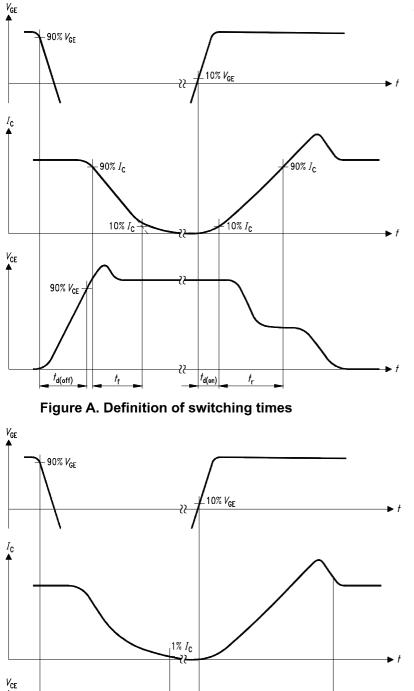
6.00

6.30



IKW30N60H3

High speed switching series third generation



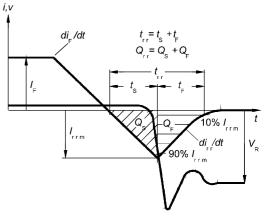


Figure C. Definition of diodes switching characteristics

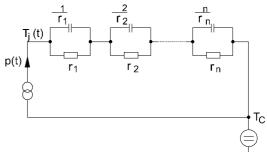


Figure D. Thermal equivalent circuit

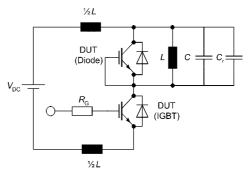


Figure E. Dynamic test circuit Leakage inductance L= 180nH, Stray capacitor $C_{\sigma} = 40 pF$, Relief capacitor C_r = 1nF (only for ZVT switching)

 t_2 Figure B. Definition of switching losses

t3

 $E_{\rm ON} = \int V_{\rm CE} \times I_{\rm C} \times {\rm d}t$

 $E_{\text{OFF}} = \int V_{\text{CE}} \times I_{\text{C}} \times dt$

*†*₁

3% V_{CE}

t,



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